

N-channel MOS-FET			
250V	0,18Ω	18A	80W

> **Features**

- High Speed Switching
- Low On-Resistance
- No Secondary Breakdown
- Low Driving Power
- High Voltage
- VGS = ± 30V Guarantee
- Avalanche Proof

> **Applications**

- Switching Regulators
- UPS
- DC-DC converters
- General Purpose Power Amplifier

> **Maximum Ratings and Characteristics**

- Absolute Maximum Ratings (TC=25°C), unless otherwise specified

Item	Symbol	Rating	Unit
Drain-Source-Voltage	V _{DS}	250	V
Drain-Gate-Voltage (R _{GS} =20KΩ)	V _{DGR}	250	V
Continous Drain Current	I _D	18	A
Pulsed Drain Current	I _{D(puls)}	72	A
Gate-Source-Voltage	V _{GS}	±30	V
Max. Power Dissipation	P _D	80	W
Operating and Storage Temperature Range	T _{ch}	150	°C
	T _{stg}	-55 ~ +150	°C

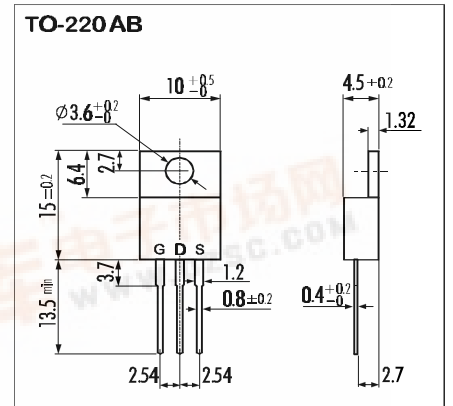
- Electrical Characteristics (TC=25°C), unless otherwise specified

Item	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown-Voltage	V _{(BR)DSS}	I _D =1mA V _{GS} =0V	250			V
Gate Threshold Voltage	V _{GS(th)}	I _D =1mA V _{DS} =V _{GS}	2,5	3,0	3,5	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =250V T _{ch} =25°C		10	500	μA
		V _{GS} =0V T _{ch} =125°C		0,2	1,0	mA
Gate Source Leakage Current	I _{GSS}	V _{GS} =±30V V _{DS} =0V		10	100	nA
Drain Source On-State Resistance	R _{DS(on)}	I _D =9A V _{GS} =10V		0,13	0,18	Ω
Forward Transconductance	g _{fs}	I _D =9A V _{DS} =25V	7,0	14,0		S
Input Capacitance	C _{iss}	V _{DS} =25V		1750	2650	pF
Output Capacitance	C _{oss}	V _{GS} =0V		290	440	pF
Reverse Transfer Capacitance	C _{rss}	f=1MHz		65	100	pF
Turn-On-Time t _{on} (t _{on} =t _{d(on)} +t _r)	t _{d(on)}	V _{CC} =150V		30	45	ns
	t _r	I _D =18A		50	75	ns
Turn-Off-Time t _{off} (t _{off} =t _{d(off)} +t _f)	t _{d(off)}	V _{GS} =10V		80	120	ns
	t _f	R _{GS} =10 Ω		70	110	ns
Avalanche Capability	I _{AV}	L = 100μH T _{ch} =25°C	18			A
Continous Reverse Drain Current	I _{DR}				18	A
Pulsed Reverse Drain Current	I _{DRM}				72	A
Diode Forward On-Voltage	V _{SD}	I _F =2xI _{DR} V _{GS} =0V T _{ch} =25°C		1,0	1,5	V
Reverse Recovery Time	t _{rr}	I _F =I _{DR} V _{GS} =0V		150		ns
Reverse Recovery Charge	Q _{rr}	-dI _F /dt=100A/μs T _{ch} =25°C		1		μC

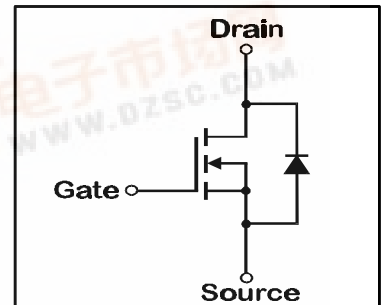
- Thermal Characteristics

Item	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Thermal Resistance	R _{th(ch-a)}	channel to air			75	°C/W
	R _{th(ch-c)}	channel to case			1,56	°C/W

> **Outline Drawing**



> **Equivalent Circuit**



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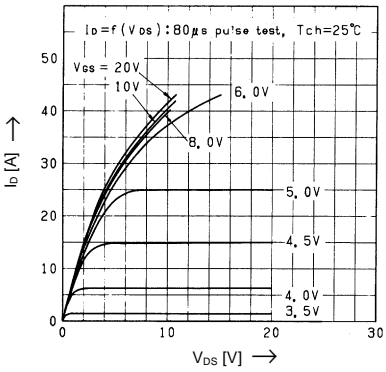
2SK2256-01

FAP-IIA Series

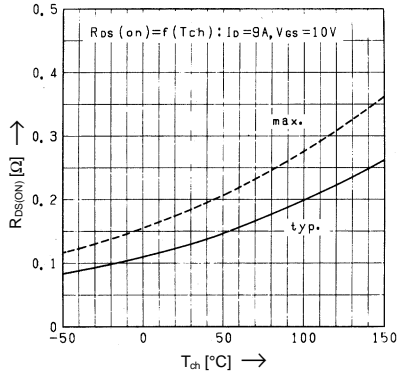


> Characteristics

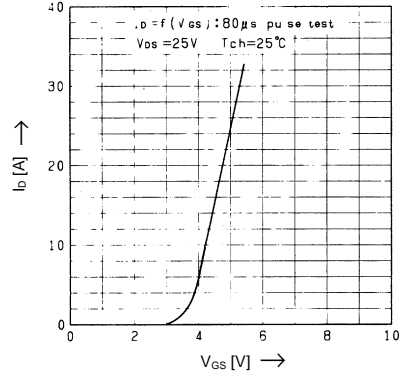
Typical Output Characteristics



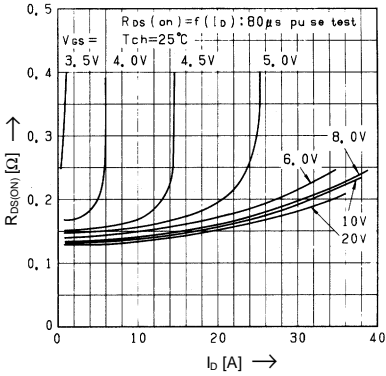
Drain-Source-On-State Resistance vs. T_{ch}



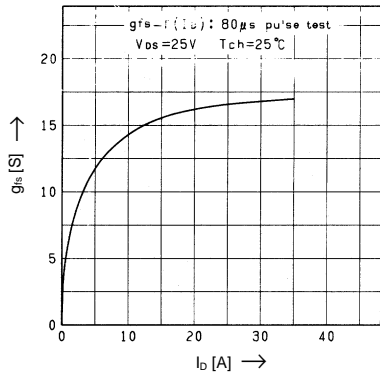
Typical Transfer Characteristics



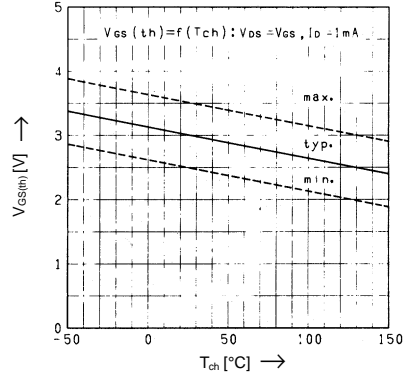
Typical Drain-Source-On-State-Resistance vs. Id



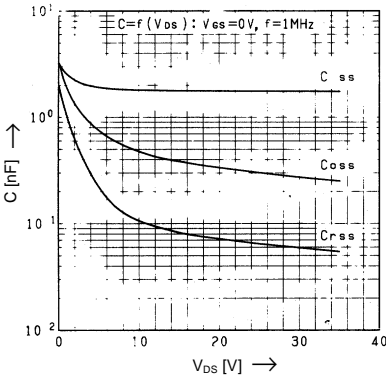
Typical Forward Transconductance vs. Id



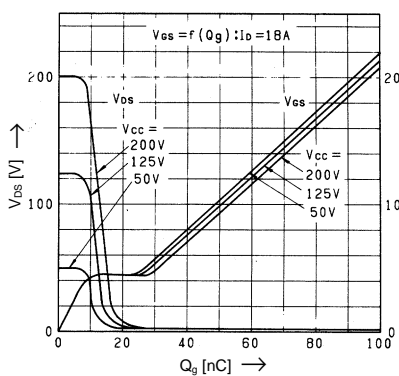
Gate Threshold Voltage vs. T_{ch}



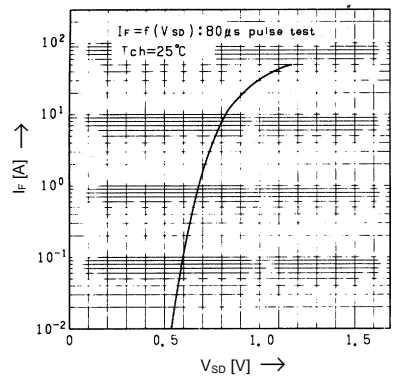
Typical Capacitance vs. V_{DS}



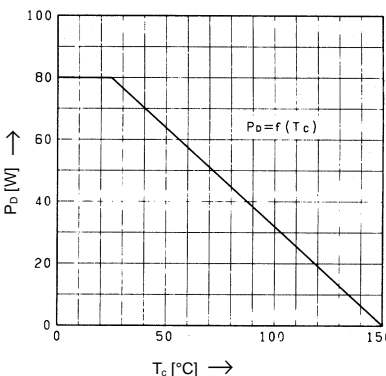
Typical Input Charge



Forward Characteristics of Reverse Diode



Allowable Power Dissipation vs. T_c



Safe operation area

